



NCE N and P-Channel Enhancement Mode Power MOSFET

D2 Description The NCE6602 uses advanced trench technology to provide excellent R_{DS(ON)}, low gate charge. This device is suitable for use as a Battery protection or in other Switching application. G1 G2 **General Features** N-channel P-channel • N-Channel Schematic diagram • V_{DS} = 30V,I_D = 3.5A S D 8 $R_{DS(ON)}$ <58m Ω @ V_{GS}=10V $R_{DS(ON)} < 95m\Omega @ V_{GS}=4.5V$ <u>م</u>ا • P-Channel 6602 $V_{DS} = -30V, I_{D} = -2.7A$ $R_{DS(ON)} < 100 m\Omega @ V_{GS} = -10V$ $R_{DS(ON)} < 150 m\Omega @ V_{GS} = -4.5 V$ В Marking and pin Assignment Low On-Resistance • Low Input Capacitance • Fast Switching Speed • Low Input/Output Leakage

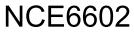
Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity			
6602	NCE6602	TSOT23-6L	Ø180mm	8mm	4000 units			
Absolute Maximum Ratings (T ₄ =25°Cunless otherwise noted)								

TSOT23-6L top view

N-Channel 30	P-Channel	Unit	
30	-30		
		V	
±20	±20	V	
3.5	-2.7	А	
3	-2.1	A	
20	-15	А	
1.	W		
-55 To 150	-55 To 150	°C	
N-Ch	104	°C/W	
P-Ch	104	°C/W	
	3.5 3 20 1. -55 To 150 N-Ch	3.5 -2.7 3 -2.1 20 -15 1.2 -55 To 150 -55 To 150 N-Ch 104	





N-CH Electrical Characteristics (T_A=25[°]C unless otherwise noted)

Parameter Sym		Condition	Min	Тур	Max	Unit
Off Characteristics			•			•
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	30	33	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	I _{GSS} V _{GS} =±20V,V _{DS} =0V		-	±100	nA
On Characteristics (Note 3)						•
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.2	1.5	2.2	V
Drain Courses On State Desistence	Б	V _{GS} =10V, I _D =3.5A	-	36	58	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =2A	-	60	95	mΩ
Forward Transconductance	G FS	V _{DS} =5V,I _D =3.1A	-	4	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}		-	210	-	PF
Output Capacitance	C _{oss}	V _{DS} =15V,V _{GS} =0V, F=1.0MHz	-	35	-	PF
Reverse Transfer Capacitance	C _{rss}		-	23	-	PF
Switching Characteristics (Note 4)			•			•
Turn-on Delay Time	t _{d(on)}		-	4.5	-	nS
Turn-on Rise Time	tr	V_{DD} =15V, R _L =3 Ω	-	1.5	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{GEN} =6 Ω	-	18.5	-	nS
Turn-Off Fall Time	t _f		-	15.5	-	nS
Total Gate Charge	Qg		-	5	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =15V,I _D =3.5A,	-	0.55	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	1	-	nC
Drain-Source Diode Characteristics					1	
Diode Forward Voltage (Note 3)	V _{SD}	V_{GS} =0V,I _S =3.5A	-	0.8	1.2	V
Diode Forward Current (Note 2)	I _S		-	-	3.5	А

Notes:

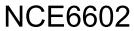
1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, t \leq 10 sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production





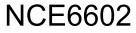
P-CH Electrical Characteristics (T_A=25℃ unless otherwise noted)

Parameter Symbol		Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA		-33	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-30V,V _{GS} =0V	-	-	-1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V		-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-250µA	-1	-1.6	-2.5	V
		V _{GS} =-10V, I _D =-2.7A	-	69	100	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-2A	-	110	150	mΩ
Forward Transconductance	g fs	V _{DS} =-10V,I _D =-2.7A		2	-	S
Dynamic Characteristics (Note4)			J			
Input Capacitance	C _{lss}			199	-	PF
Output Capacitance	C _{oss}	- V _{DS} =-15V,V _{GS} =0V, F=1.0MHz	-	47	-	PF
Reverse Transfer Capacitance	C _{rss}			28	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	8	-	nS
Turn-on Rise Time	tr	V _{DD} =-15V,R _L =15Ω	-	5	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =-10V,R _{GEN} =6Ω	-	12	-	nS
Turn-Off Fall Time	t _f		-	4	-	nS
Total Gate Charge	Qg		-	5	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =-15V,I _D =-2.7A,V _{GS} =-10V	-	0.7	-	nC
Gate-Drain Charge	Q _{gd}]	-	1.1	-	nC
Drain-Source Diode Characteristics	·		•		-	•
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-2.7A	-	-	-1.2	V

Notes:

- **1.** Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production





N- Channel Typical Electrical and Thermal Characteristics

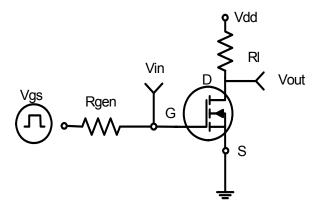
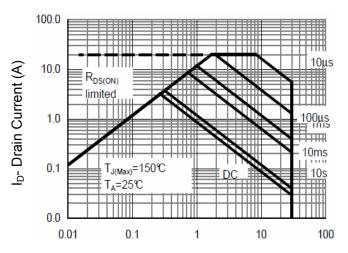
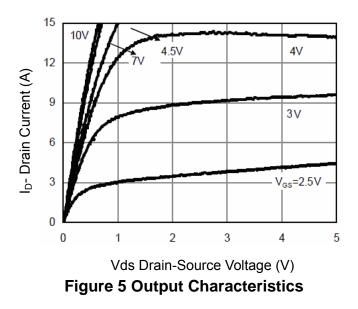


Figure 1:Switching Test Circuit



Vds Drain-Source Voltage (V) Figure 3 Safe Operation Area



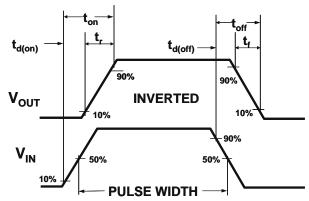


Figure 2:Switching Waveforms

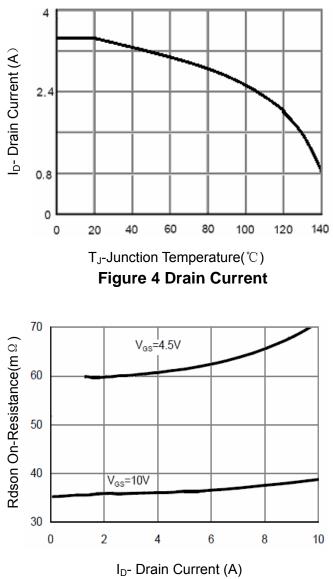
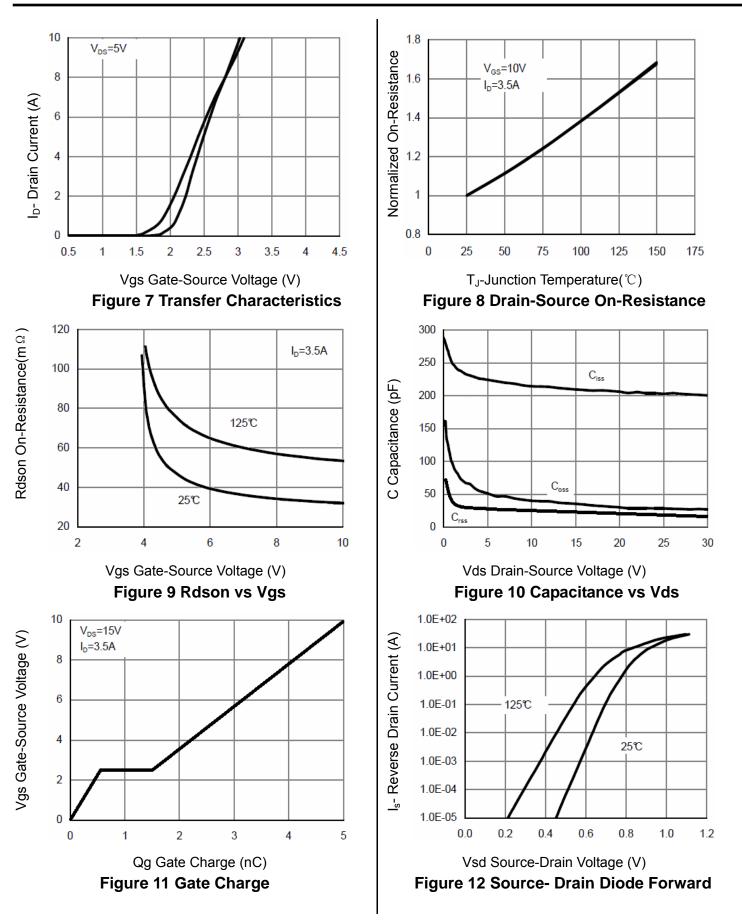


Figure 6 Drain-Source On-Resistance



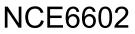


NCE6602









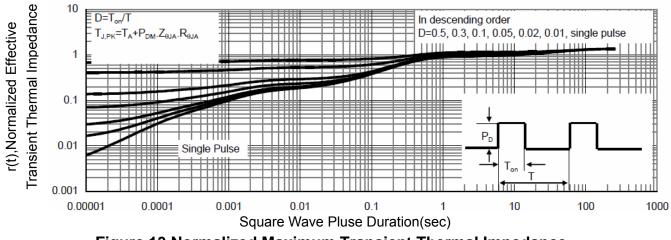
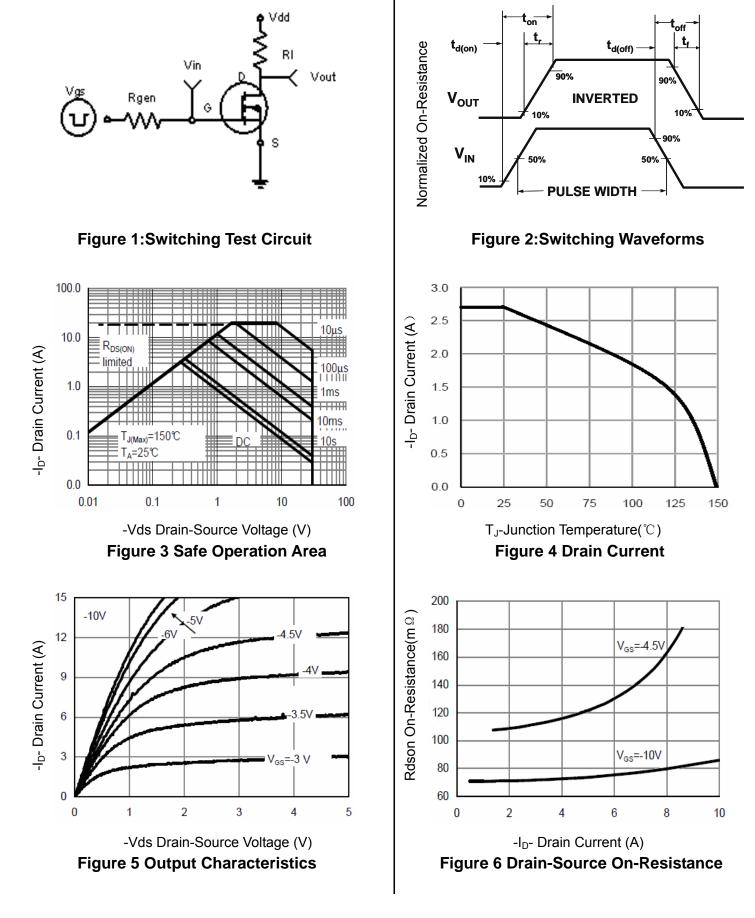


Figure 13 Normalized Maximum Transient Thermal Impedance





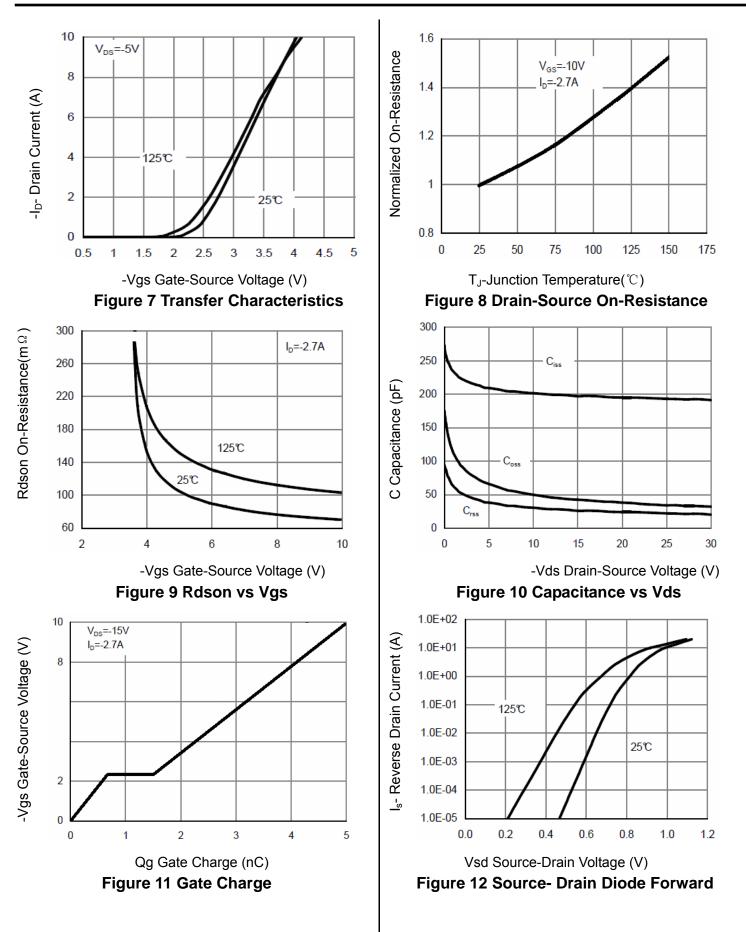
P- Channel Typical Electrical and Thermal Characteristics





Pb Free Product

NCE6602





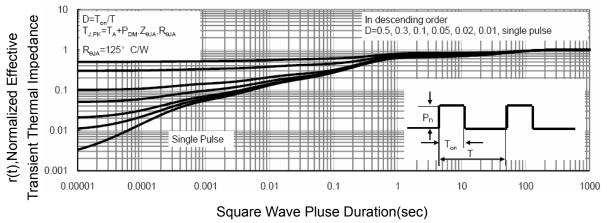


Figure 13 Normalized Maximum Transient Thermal Impedance

Pb Free Product

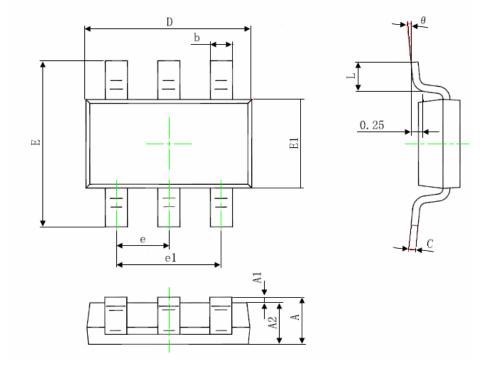
NCE6602







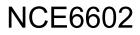
TSOT23-6L Package Information



Symbol	Dimensions Ir	n Millimeters	Dimensions In Inches			
Symbol	Min	Max	Min	Max		
А		0.900		0.035		
A1	0.000	0.100	0.000	0.004		
A2	0.700	0.800	0.028	0.031		
b	0.350	0.500	0.014	0.020		
с	0.080	0.200	0.003	0.008		
D	2.820	3.020	0.111	0.119		
E1	1.600	1.700	0.063	0.067		
E	2.650	2.950	0.104	0.116		
е	0.95 (E	BSC)	0.037	0.037(BSC)		
e1	1.90 (E	BSC)	0.075(BSC)			
L	0.300	0.600	0.012	0.024		
θ	0°	8°	0°	8°		







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